

**Patent**

Customer No.: 31561  
Docket No. 8012-US-PA  
Application No.: 10/065,632

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Applicant : Weng  
Application No. : 10/065,632  
Filed : Nov. 5, 2002  
For : CHIP STRUCTURE WITH BUMPS AND A PROCESS  
FOR FABRICATING THE SAME  
Art Unit : 2814  
Examiner : HA, NATHAN W

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JAN 14 2004

**OFFICIAL****TRANSMITTAL LETTER**

002-1-703-872-9306

(Via fax: 11 pages, followed by confirmation copy via courier)

Assistant Commissioner for Patents  
Arlington, Virginia 22202

Dear Sirs,

In response to the Office Action dated October 14, 2003, please find the relevant paper in response to paper No. 7. Following the fax transmission, a hard copy via courier will also be forwarded to the Office.

Enclosed documents via courier will include:

- ☒ Amendment and Response to Office Action in (9) pages
- ☒ Fax confirmation report
- ☒ Prepaid return postcard
- ☐ Extension fee

I believe that no fee is incurred. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 8012-US-PA)

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

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Respectfully Submitted,  
JIANQ CHYUN Intellectual Property Office

Date: Jan 14, 2004

By: Belinda Lee  
Belinda Lee  
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